



FR-860

PREHEAT PLATE



The **HAKKO FR-860 Preheat Plate** is designed specifically for the automotive and telecommunications industries. The low profile and large, even heat surface across the plate provides fast, efficient heat.



FEATURES & BENEFITS

- Ideal for PCB's bonded to solid metal substrates
- Temperature control feedback from either plate or remote thermocouple
- Split plate/controller design allows for minimal bench space use
- Low profile allows for use under microscopes
- Preheat plate does not warp over time
- ESD Safe



SPECIFICATIONS For Part No. FR860-02

Power Consumption	600 W
Temperature Range	RT - 500 °F / RT-260 °C
Temperature Stability	± 9 °F / ± 5 °C
Temperature Control	Industrial Microprocessor
Temperature Control Modes	Plate or External Thermocouple
Thermocouple Inputs	1 - Type K
Heating Surface Dimensions (W x D)	7.0 x 7.0 in. / 178 x 178 mm
Overall Dimensions (Plate) (W x H x D)	9.8 x 3.1 x 8.0 in. / 250 x 79 x 204 mm
Overall Dimensions (Controller)	3.9 x 2.6 x 6.7 in. / 100 x 66 x 169 mm

FR-860 PREHEAT PLATE

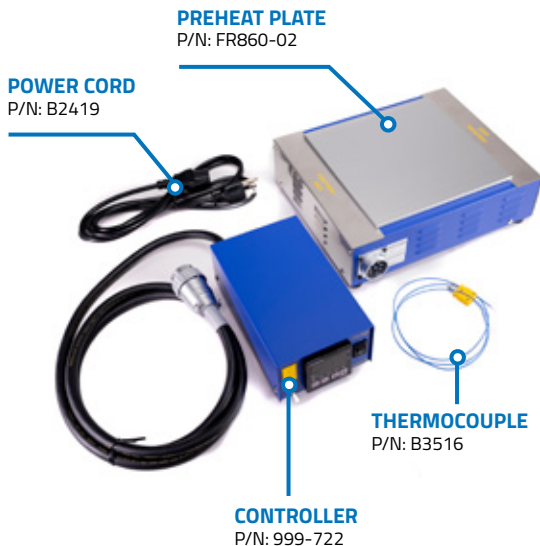
P/N: FR860-02



CONTENTS

Part No.	Description
999-722	Controller
FR860-02	Preheat plate (large)
B2419	Power cord
B3516	Thermocouple (type k)
--	Instruction manual

REWORK



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